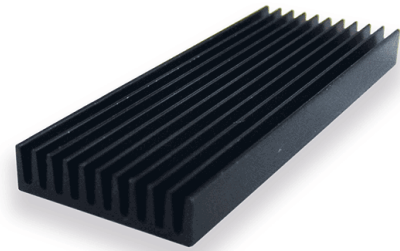


## Product Data Sheet Type: PR8/51/SE

Group: HEATSINKS Board Level

For single mounting

Width :	18.9 mm
Height :	4.8 mm
Length :	51 mm
Minimum thermal resistance :	8,5 K/W
For device :	DIL
Device mounted by :	Bonding
Heatsink mounted by :	Adhesive Bonding
Surface :	Black Anodised
Material :	AlMgSi0,5



- Extruded heatsinks especially for IC's in DUAL IN LINE case.
- Mounting by single component thermal conductive adhesive type WK 709.
- Standard length:
  - 6,3 mm for 14/16 pins
  - 33 mm for 24 pins
  - 37 mm for 28 pins
  - 47 mm for 35 pins
  - 51 mm for 40 pins
- Other lengths and machining on request.

